# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
DINKESH HUDERI SOMANNA	05/28/2021
BRIAN T. WEST	05/28/2021
JEONGHOON OH	05/28/2021

# **RECEIVING PARTY DATA**

Name:	Applied Materials, Inc.	
Street Address:	3050 Bowers Avenue	
City:	Santa Clara	
State/Country:	CALIFORNIA	
Postal Code:	95054	

# **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17328855

# **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 44019629US1

NAME OF SUBMITTER: ALAN TABOADA

SIGNATURE: /ALAN TABOADA/

DATE SIGNED: 06/07/2021

**Total Attachments: 2** 

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PATENT 506700350 REEL: 056451 FRAME: 0500

Case No. 44019629US01

### ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

#### **Dinkesh HUDERI SOMANNA**

3320 Scott Blvd. Santa Clara, CA 95054

#### Brian T. WEST

Applied Materials 3320 Scott Blvd. M/S 1100 Santa Clara CA 95054

#### Jeonghoon OH

M/S 81107 974 E. Arques Ave. Sunnyvale, CA 94085

(hereinafter referred to as Assignors), have invented a certain invention entitled:

# MAGNETRON ASSEMBLY HAVING COOLANT GUIDE FOR ENHANCED TARGET COOLING

for which application for Letters Patent in the United States was executed on even date herewith; and

for which we have filed an application for a Patent of the United States on May 24, 2021, Serial No. 17/328,855 (and for which we authorize counsel to insert the filing date and serial number if known after the date of execution of this assignment); and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignor, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of

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PATENT REEL: 056451 FRAME: 0501 any of said Patents.

- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

5/28/2021	(DATE)	Dinkesh Huderi Somanna
		47DB8D8CB7FE4FDinkesh HUDERI SOMANNA
5/28/2021	(DATE)	DocuSigned by:
		F788431EFFEA499 Brian T. WEST
5/28/2021	(DATE)	_Jeonghoon Ott
	, ,	DDEB15087653404Jeonghoon OH

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RECORDED: 06/07/2021

PATENT REEL: 056451 FRAME: 0502